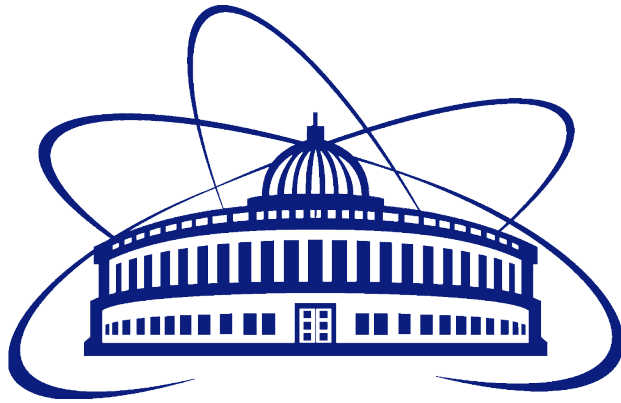


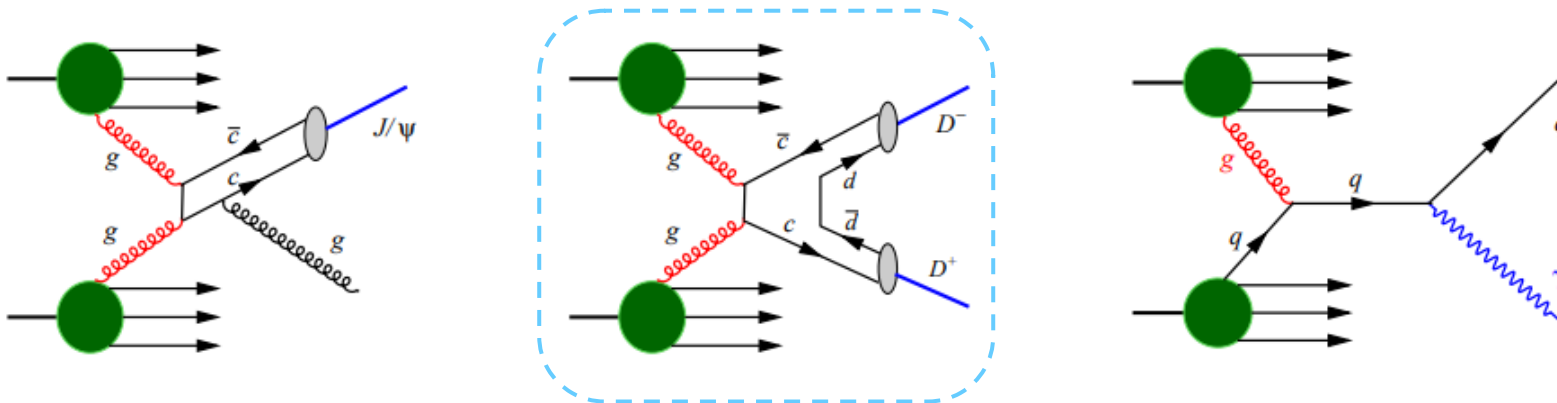


Status of vertex detector simulation

Vasyukov Artem
Email: avasyukov@jinr.ru

Introduction

- **Vertex detector** is responsible for precise determination of the primary interaction point and measurement of the secondary vertices from the decays of short-lived particles.



- On 1st stage Micromegas-based Central tracker will be installed;
- On 2d stage SVD (DSSD or MAPS) is planned to be installed;
- D^0 decay length $123 \mu\text{m}$ $\Rightarrow$ secondary vertex resolution $\sim 50\text{-}80 \mu\text{m}$ is required;
- Only ST shows unsatisfactory performance in the reconstruction of position of secondary vertex (see Ap. 1);
- Reconstructions of tracks from high pseudorapidity region is important for D-meson TSSA measurements;

Overview of VD options

Stage 1 of SPD operation

- MicroMegas-based central tracker: 1 barrel (super)layer;
 - With electronic modules (types#1,#2);
 - Without electronic modules;

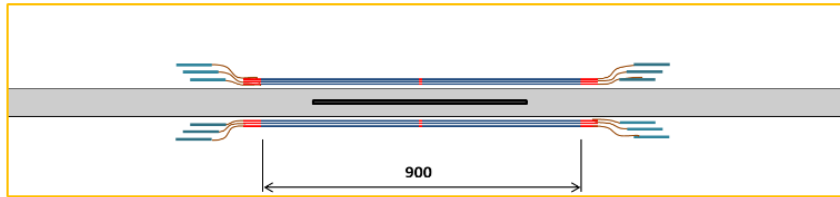
Stage 2 of SPD operation

- DSSD TDR config: 3 barrel layers ($\sim 0.53\% X_0$ per layer) + 3 EC layers;
- MAPS-based detector with following configs:
 - #1 4 layers in barrel only ($\sim 0.8\% X_0$ per layer), z-length 150 cm **gtype** = 3; (TDR config)
 - #2 2+2 layers in barrel only **gtype** = 2:
 - ($\sim 0.35\% X_0$ per layer), z-length 74 cm;
 - ($\sim 0.8\% X_0$ per layer), z-length 150 cm;
 - #3 4 layers in barrel ($\sim 0.35\% X_0$ per layer), z-length 74 cm + 4 EC layers ($\sim 0.3\% X_0$ per layer) **gtype** = 1; (DSSD-like config)

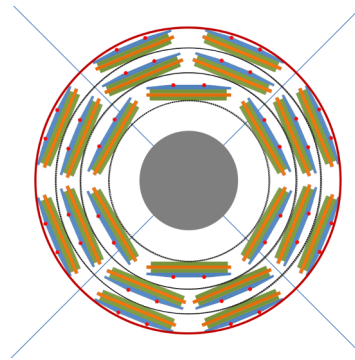
VD option | Micromegas-based Central Tracker

- The idea of the Micromegas-based Central Tracker (MCT) is to improve the momentum resolution and tracking efficiency of the main tracking system during the first period of data taking (see Ap. 4);
- 1 super layer;
- Barrel layer length: 90 cm (TDR) vs 80 cm (D. Dedovich talk);
- FEE modules were simulated;
- FEE location: 15 cm from MCT active area;

TDR



MCT + no Electronics



MCT + Electronics#1

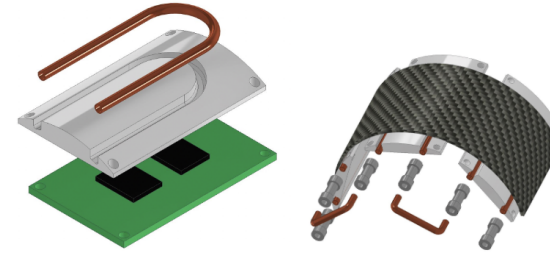
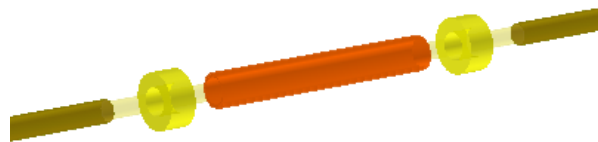
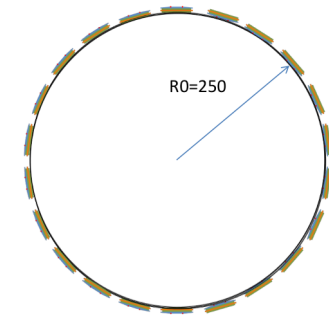
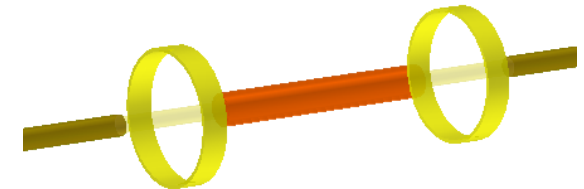


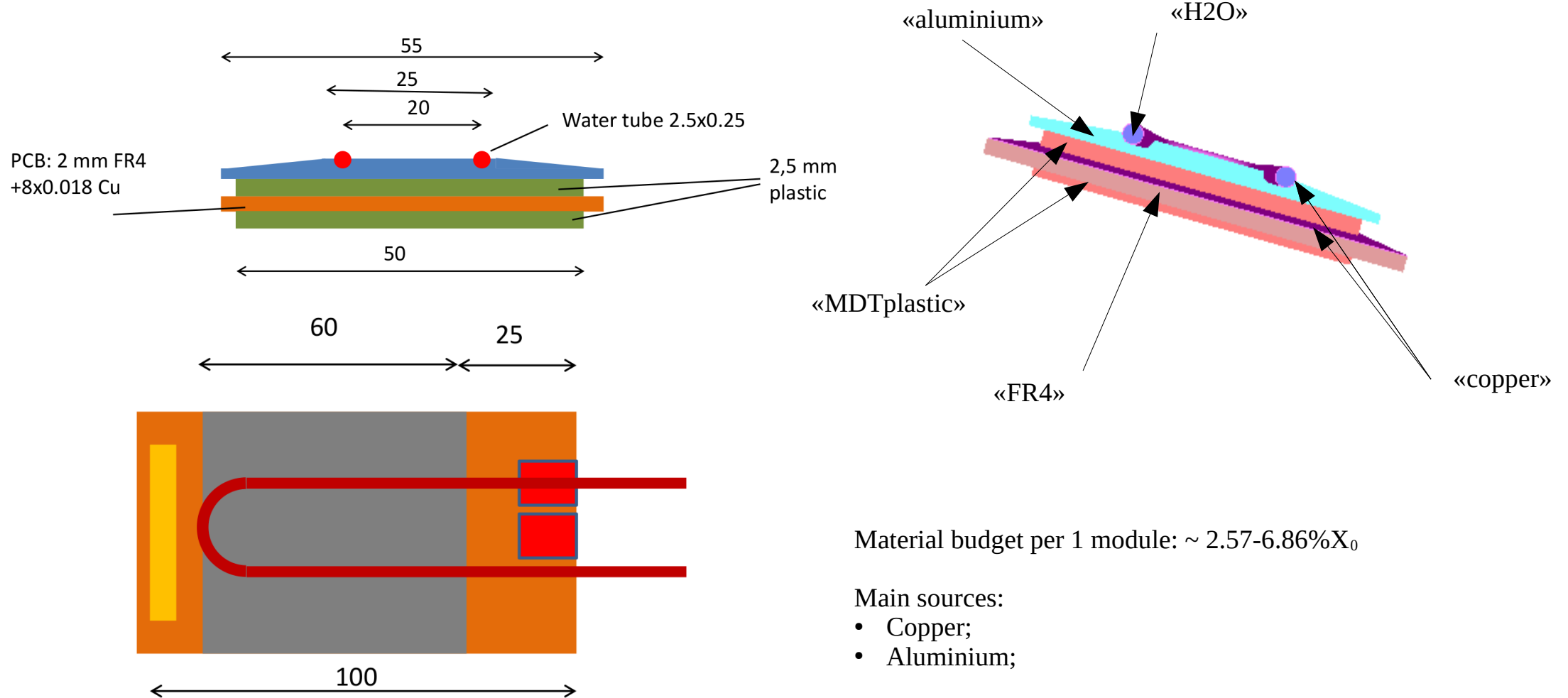
Figure 12.12: (a) Exploded-view diagram of a single cooling plate with the FE board. (b) Schematic view of the carbon fiber support structure with cooling plates fixed to it.



MCT + Electronics#2



VD option | Micromegas-based Central Tracker | FEE



Performance tests description | momentum resolution

Muon momentum resolution

- Isotopic production of 1.5 GeV muons at (0, 0, 0) point (no PV smearing);
- For MCT FEE performance tests the phase space is limited by the range of angles at which the tracks enter the electronics (see slides 7-8);
- SpdMCTrackFinder default settings:
 - Minimum number of ITS hits = 1, exception: ST only config (min ITS hits = 0) Ap. 4;
 - Minimum number of TS hits = 0;
- Each $\Delta(p_{\text{reco}} - p_{\text{gen}})/p_{\text{gen}}$ distribution is fitted with two gaussians;
- σ is weighted average of two gaussians;

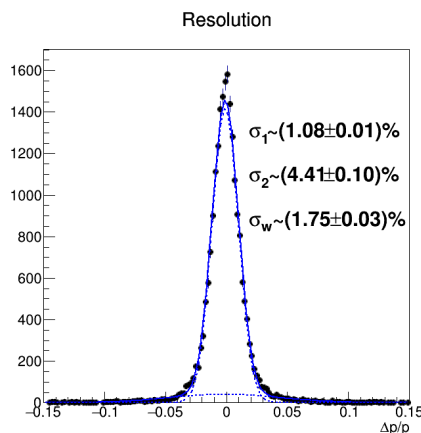
Detector setup:

- Aluminium pipe — for stage1 VD;
- Beryllium pipe — for stage2 VD;
- Magnetic field;
- Vertex detector + Straw tracker;

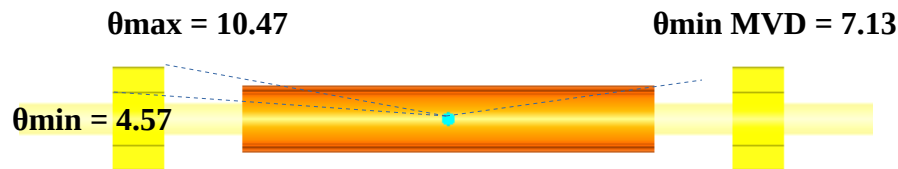
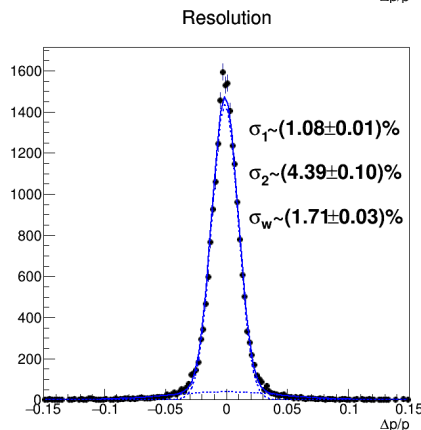
VD performance | MCT with electrics#1

MCT customize geometry: CustomMvd(3);
Barrel length: 80 cm.

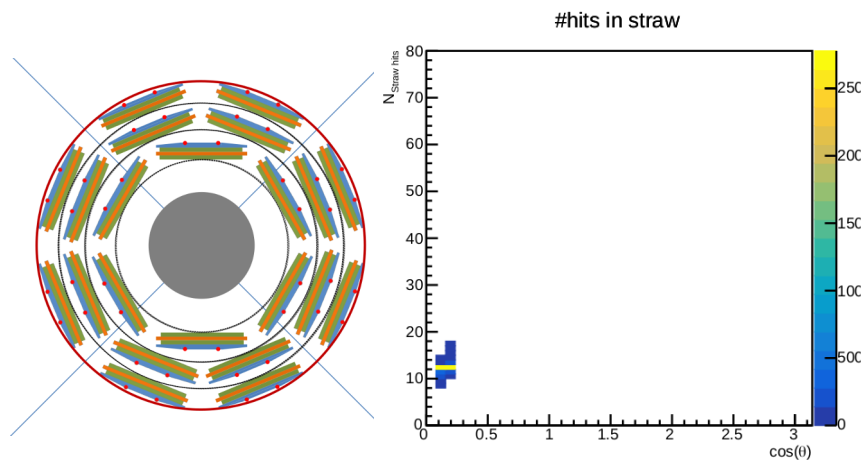
Without FE
Modules



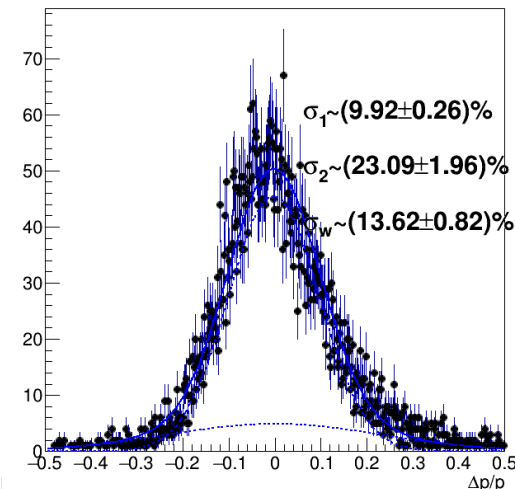
With FE
Modules



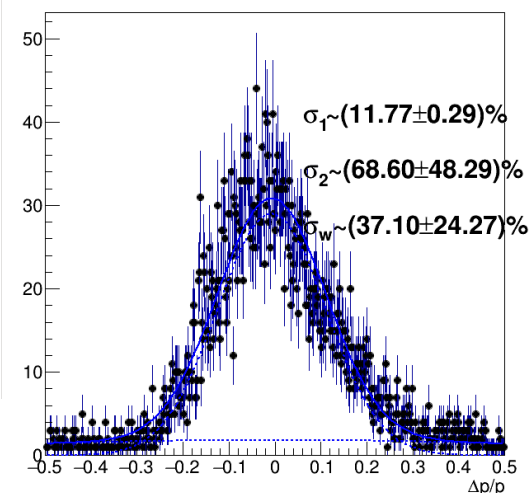
```
IGen->SetSpherical(4.5739213, 10.426010, 0., 360.);  
primGen->SetBeam(0., 0., 0., 0.);  
primGen->SetTarget(0., 0.);
```



Resolution Without FE



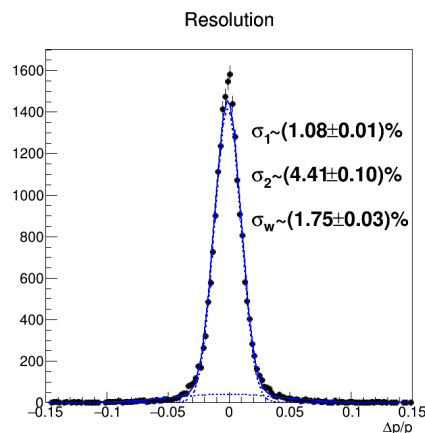
Resolution With FE



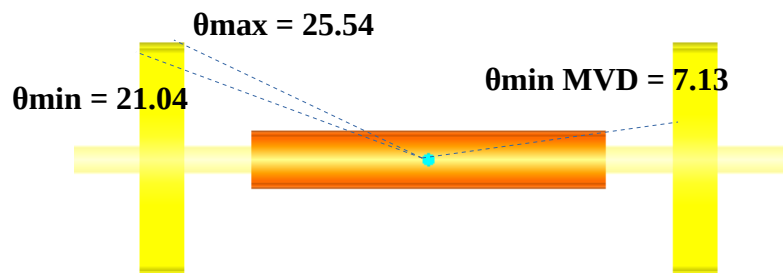
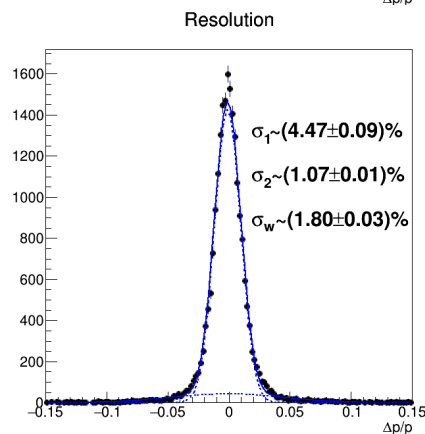
VD performance | MCT with electrics#2

MCT customize geometry: CustomMvd(3);
Barrel length: 80 cm.

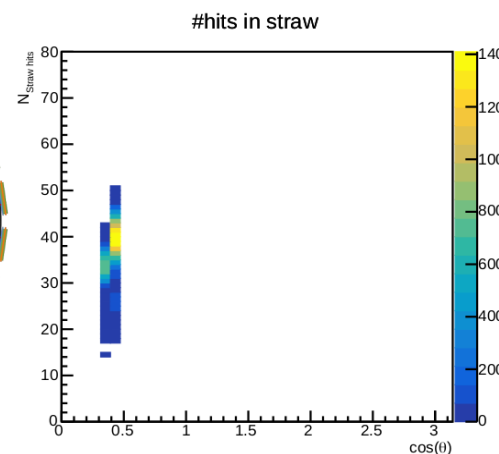
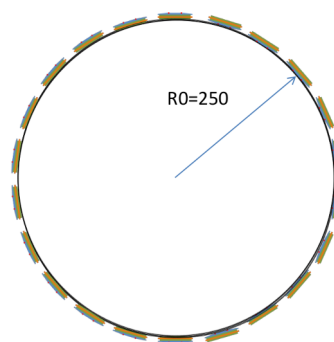
Without FE
Modules



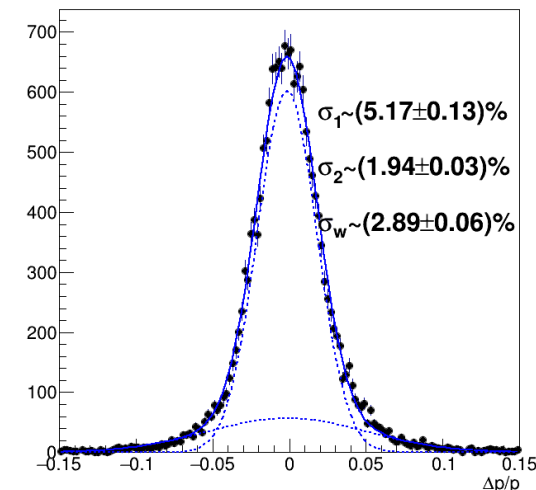
With FE
Modules



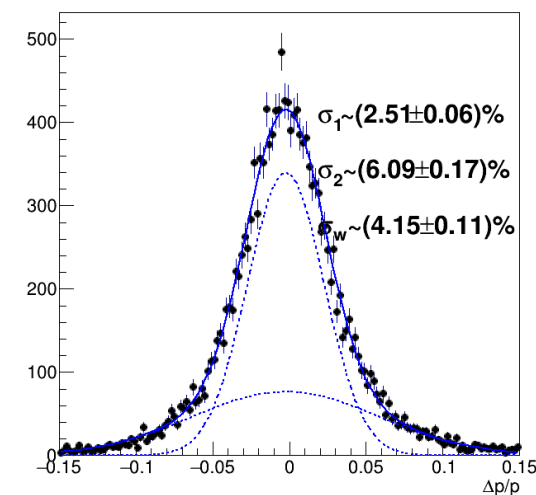
```
IGen->SetSpherical(21.037511, 25.542457, 0., 360.);  
primGen->SetBeam(0., 0., 0., 0.);  
primGen->SetTarget(0., 0.);
```



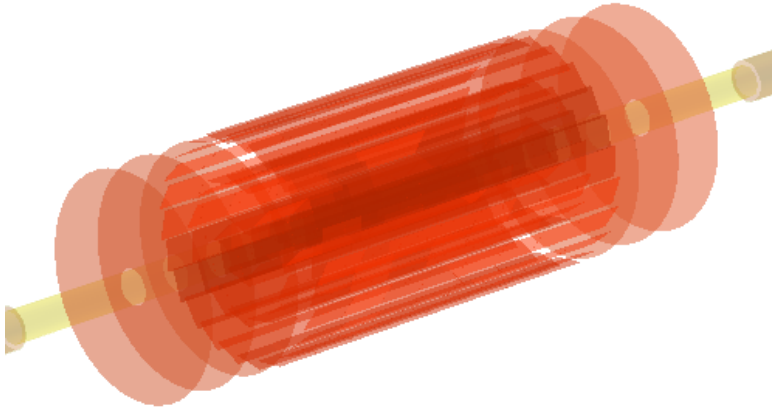
Resolution Without FE



Resolution With FE

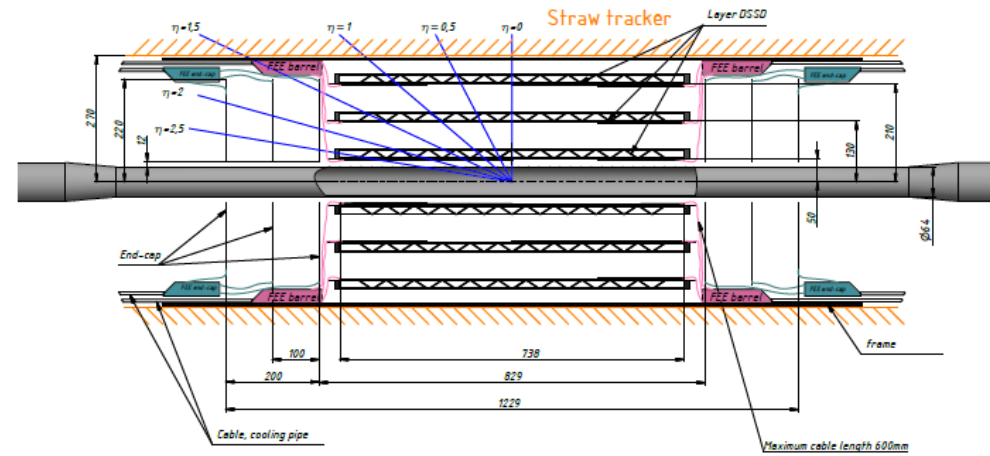


VD option | DSSD-based SVD

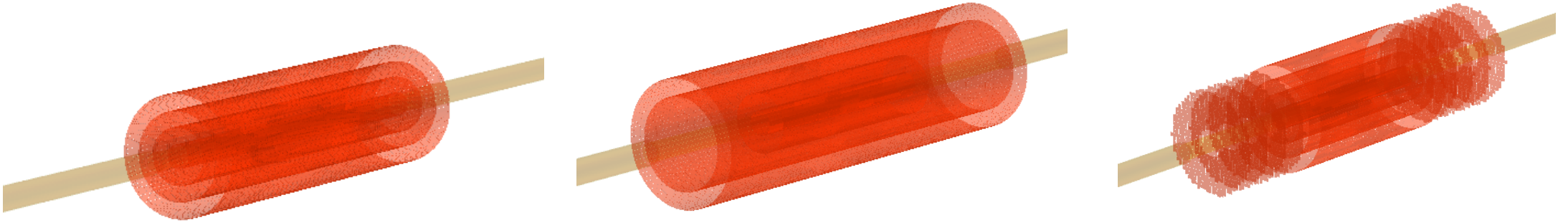


- 3 barrel layers;
- Barrel layer length: 74 cm;
- Barrel layer thickness: 500 μm ($0.53\% X_0$);
- 3 End-Cap disks: width — 300 μm , Rmin: 3.5 mm, Rmax: 22 cm;
- Positions of DSSD end-caps:
 - ± 41.45 cm; (TDR)
 - ± 51.45 cm; (TDR)
 - ± 61.45 cm; (TDR)

TDR



VD option | MAPS-based SVD



- 4 barrel layers;
- Barrel layer length: 150 cm;
- Barrel layer thickness: 750 μm (0.80% X_0);
- No End-Cap disks;

- 4 barrel layers;
- #1, #2 barrel layers length: 74 cm;
- #3, #4 barrel layers length: 150 cm;
- #1, #2 barrel layers thickness: 330 μm (0.35% X_0);
- #3, #4 barrel layers thickness: 750 μm (0.80% X_0);
- No End-Caps;

- 4 barrel layers;
- Barrel layers length: 74 cm;
- Barrel layers thickness: 330 μm (0.35% X_0);
- 4 End-Cap disks:
- $|Z_{\text{pos}}| = 45, 55, 65, 75$ cm;
- EC disks thickness: 290 μm (0.3% X_0)

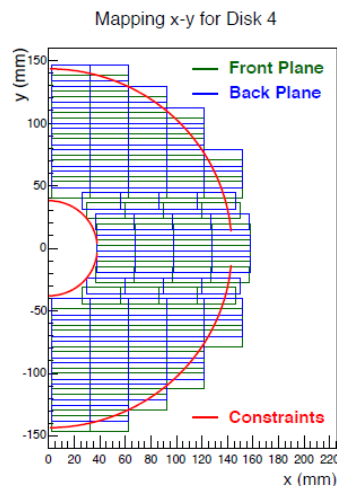
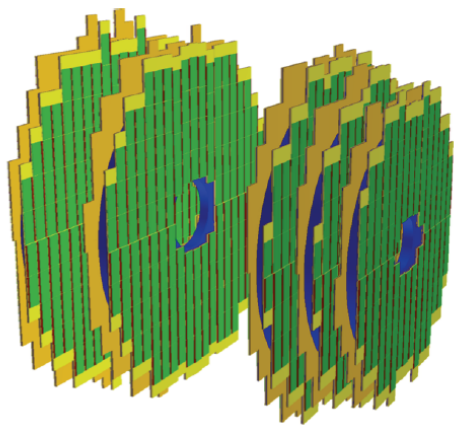
VD option | MAPS-based SVD | End-caps

Role model: Muon Forward Tracker (ALICE experiment)

TDR: <https://cds.cern.ch/record/1981898>

Detector web page:

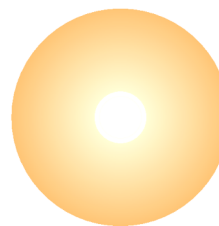
https://alice-collaboration.web.cern.ch/menu_proj_items/MFT



- It is based on Alpide chip architecture;
- Five disks, each one has 2 detection planes;
- The overlap between sensors of the back and front plane ensures the hermeticity of the half-disk;
- Material budget: 0.6% X_0 per disk

SpdRoot source code:

- EC Ladder thickness: 290 μm ($0.3\%X_0$)
 - EC Layer material budget: 290 + 290 μm of silicon
- 0.6% X_0 MFT Alice TDR;
- Distance between sensitive planes: 20 mm;
 - Rmin: 5cm;
 - Rmax: 21 cm (as for Barrel);



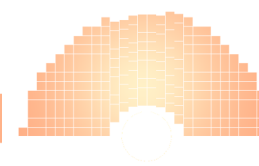
Level 1
MapsECLayer
air
TGeoTube
kFALSE



Level 2
MapsECHalfCone
air
TGeoTubs
kFALSE



Level 3
MapsECLadder
silicon
TGeoBox
kFALSE



Level 4
MapsECChip
silicon
TGeoBox
kTRUE

- To reduce material budget EC Layer for MAPS#3 config contains 2 half cones instead of 4;

Performance tests description | SV reconstruction

- Pythia 8 + SpdRoot (SpdD0Generator)
- Open-charm process, $D^0 \rightarrow \pi^+ K^-$ forced;
- Event vertex Z: Gaussian profile with $\sigma_z = 30$ cm;
- Event vertex X, Y: Gaussian profile with $\sigma_{x,y} = 0.1$ cm;
- KFParticle to reconstruct secondary vertex (D^0);
- SpdMCTrackFinder settings:
 - Minimum number of ITS hits = 2 (SVD), 1 (MVD);
 - Minimum number of TS hits = 6;
- Resolution obtained from the distribution of (Reco — MC True) secondary vertex positions;
- Only ST config shows unsatisfactory performance in the reconstruction of position of secondary vertex (see Ap. 1);

SpdD0Generator was developed by Amaresh Datta:

- D^0 partical gun with proper P_T distribution for pp collisions $\sqrt{s} = 27$ GeV;
- The PDF is presented as a two-dimensional histogram ($p - \theta$);
- Hit-and-miss method is used;

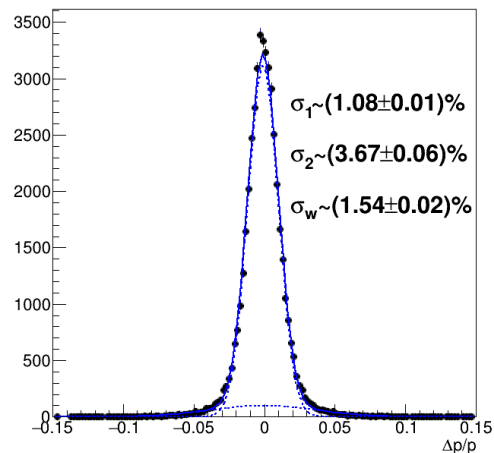
Detector setup:

- Aluminium pipe — for stage1 VD;
- Beryllium pipe — for stage2 VD;
- Magnetic field;
- Vertex detector + Straw tracker;

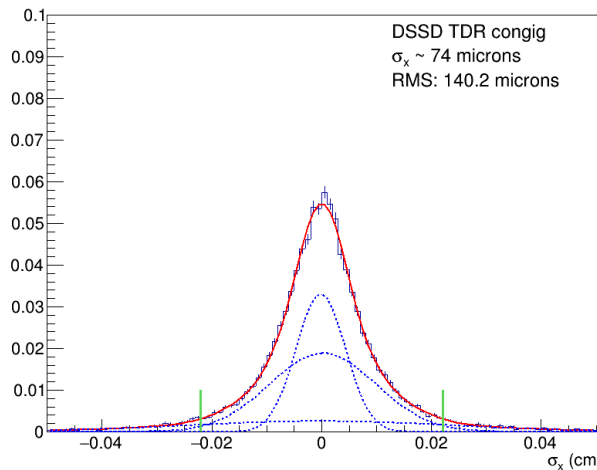
- Each normalized distribution is fitted with three gaussians;
- σ is weighted average of two narrow ones within $\sim 3\sigma$ range;
- Range shown with **green** lines;
- Third one ignored as it's almost flat in most cases;
- As an additional characteristic of the distribution, RMS is also presented;

D⁰ vertex resolution | DSSD configuration TDR

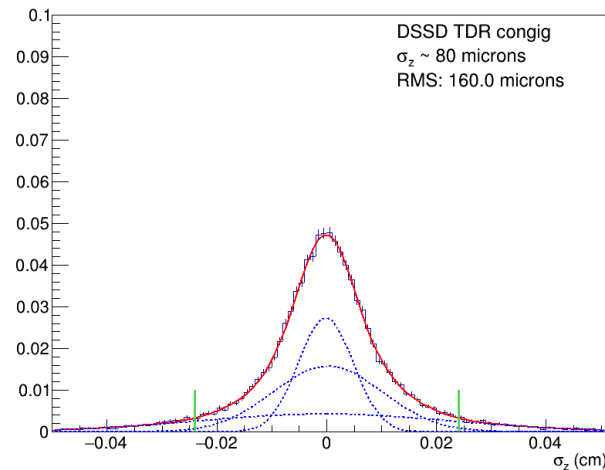
Resolution



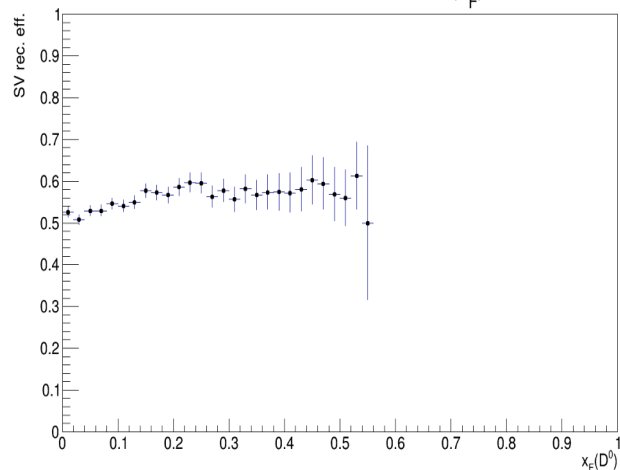
D⁰ $\rightarrow \pi^+ + K^-$: secondary vertex x-resolution



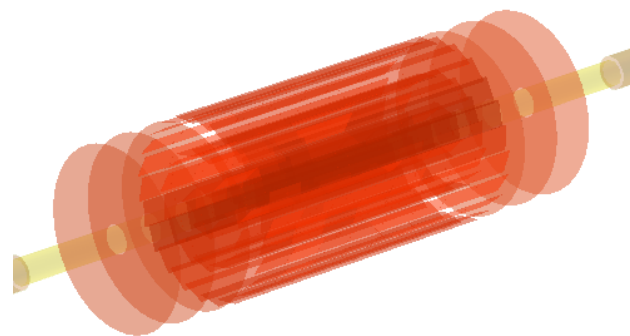
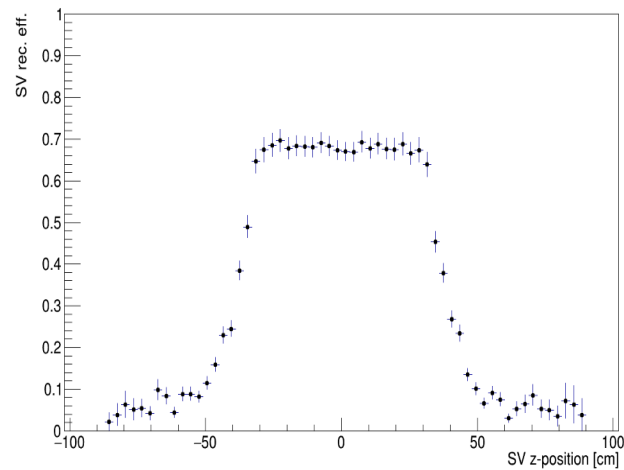
D⁰ $\rightarrow \pi^+ + K^-$: secondary vertex z-resolution



D⁰ SV reconstruction eff. (x_F)

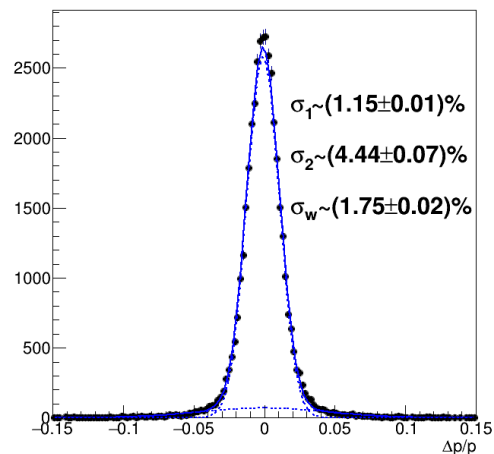


D⁰ SV reconstruction eff. (z position)

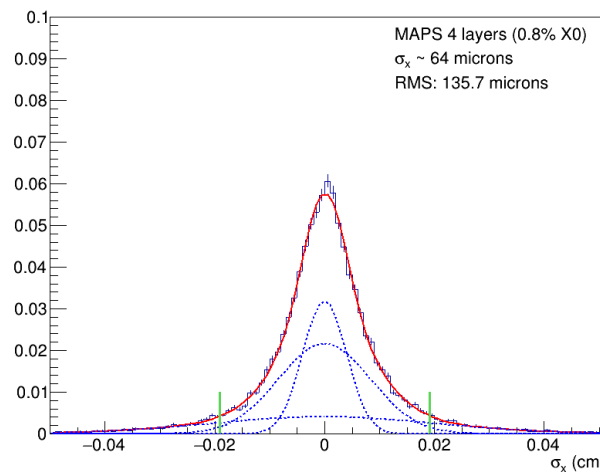


D⁰ vertex resolution | MAPS configuration #1

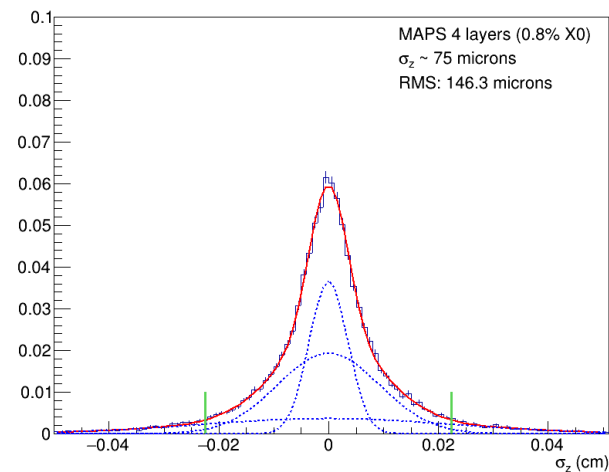
Resolution



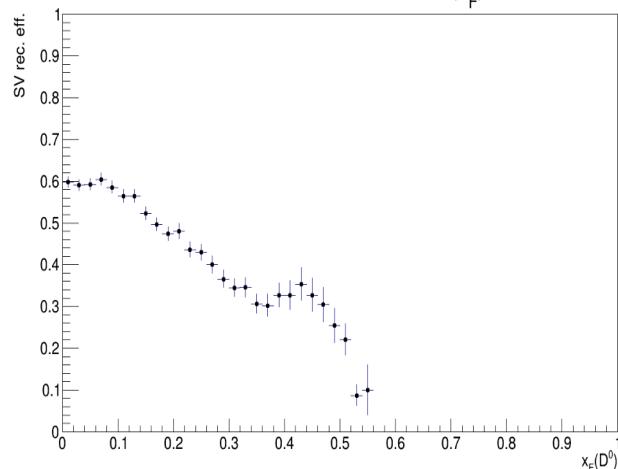
D⁰ → π^+ + K^- : secondary vertex x-resolution



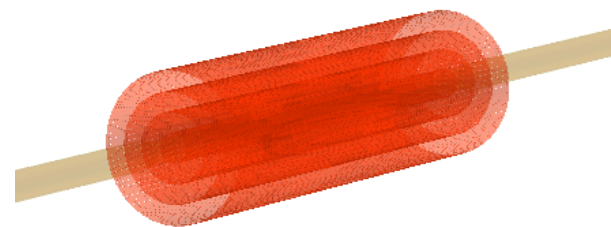
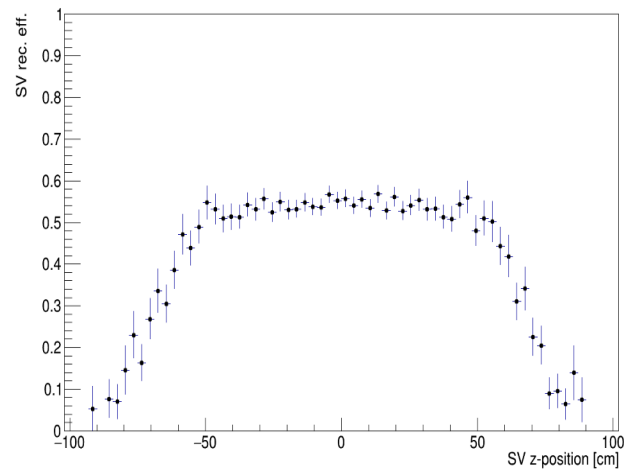
D⁰ → π^+ + K^- : secondary vertex z-resolution



D⁰ SV reconstruction eff. (x_F)

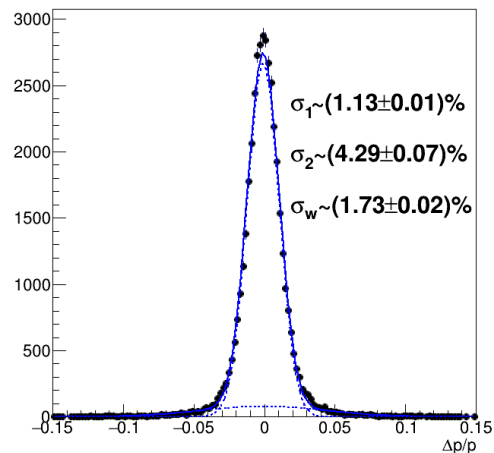


D⁰ SV reconstruction eff. (z position)

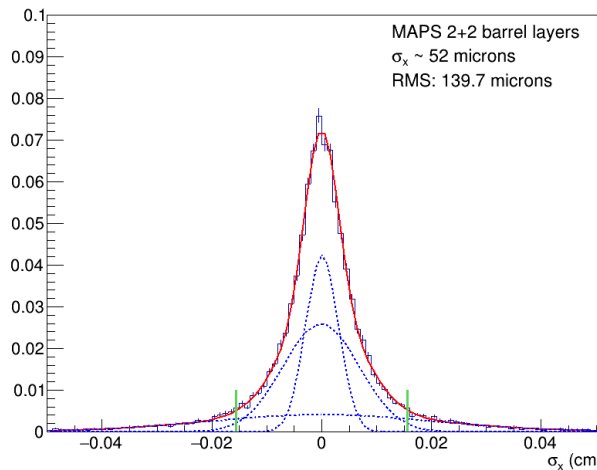


D⁰ vertex resolution | MAPS configuration #2

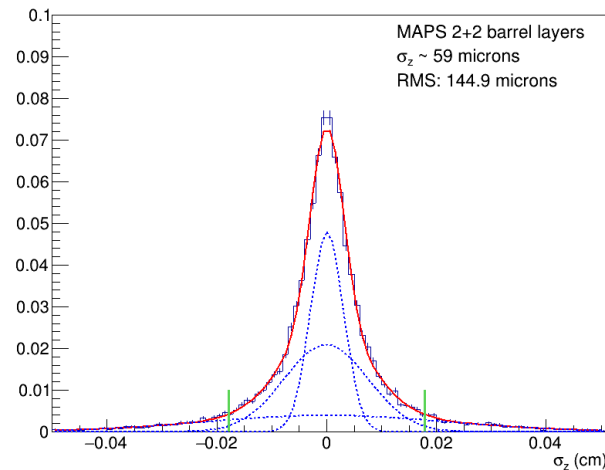
Resolution



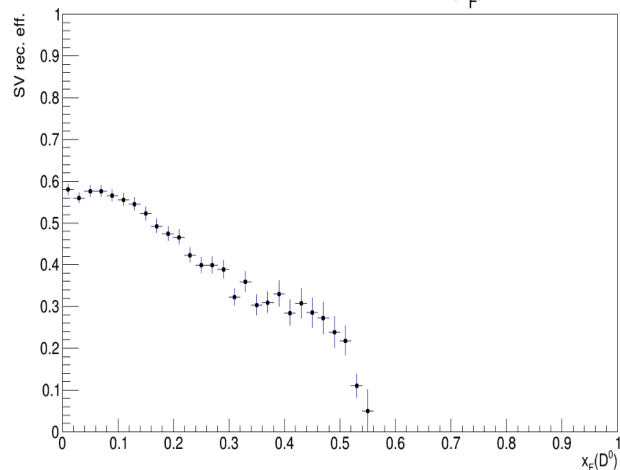
D⁰ → π^+ + K^- : secondary vertex x-resolution



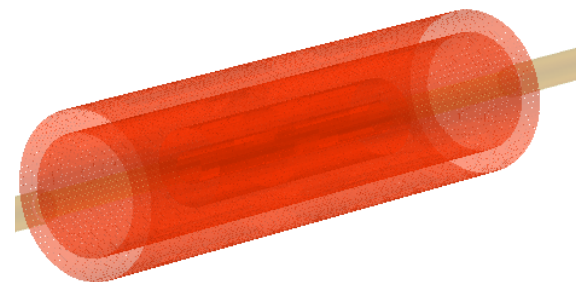
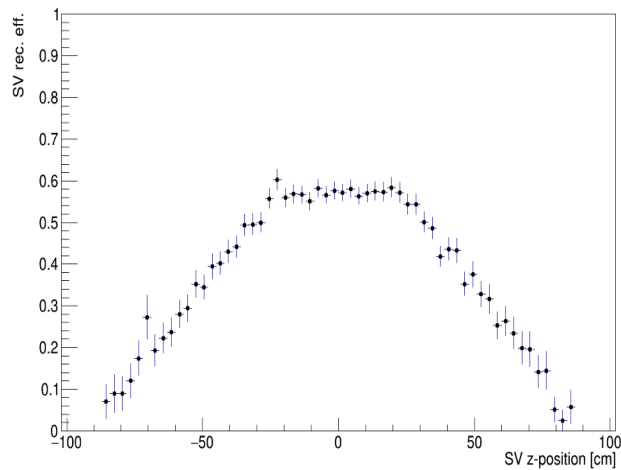
D⁰ → π^+ + K^- : secondary vertex z-resolution



D⁰ SV reconstruction eff. (x_F)

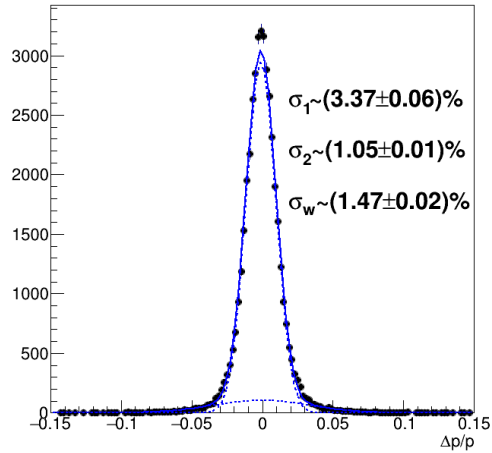


D⁰ SV reconstruction eff. (z position)

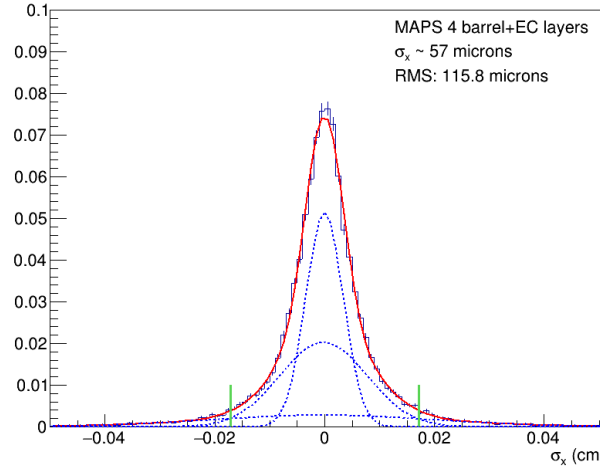


D⁰ vertex resolution | MAPS configuration #3

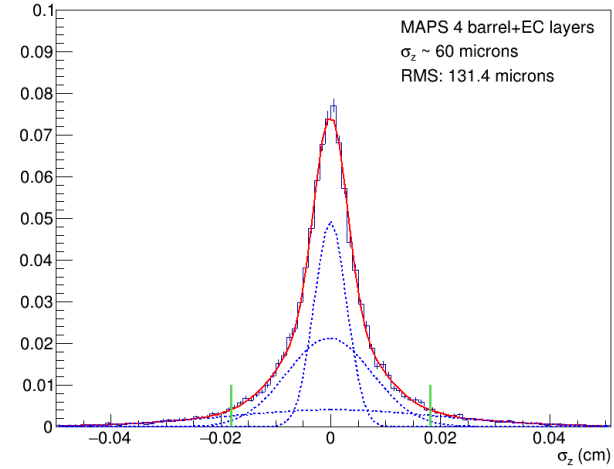
Resolution



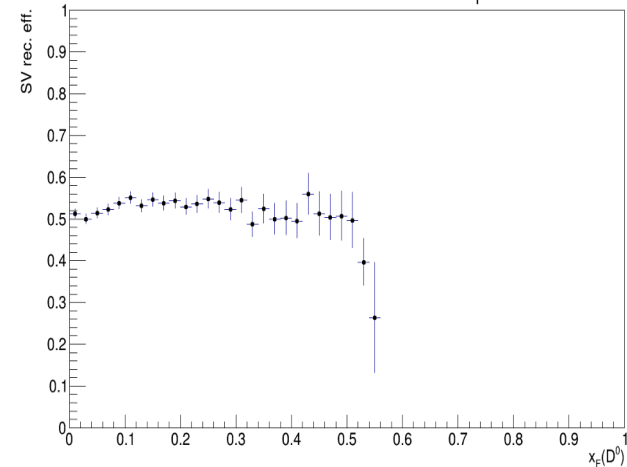
D⁰ → π^+ + K^- : secondary vertex x-resolution



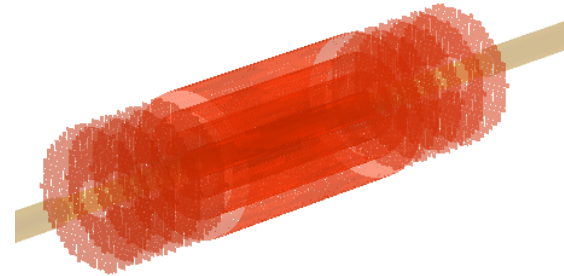
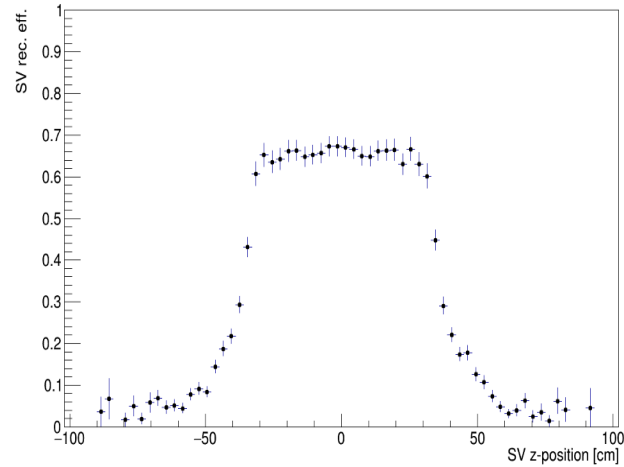
D⁰ → π^+ + K^- : secondary vertex z-resolution



D⁰ SV reconstruction eff. (x_F)

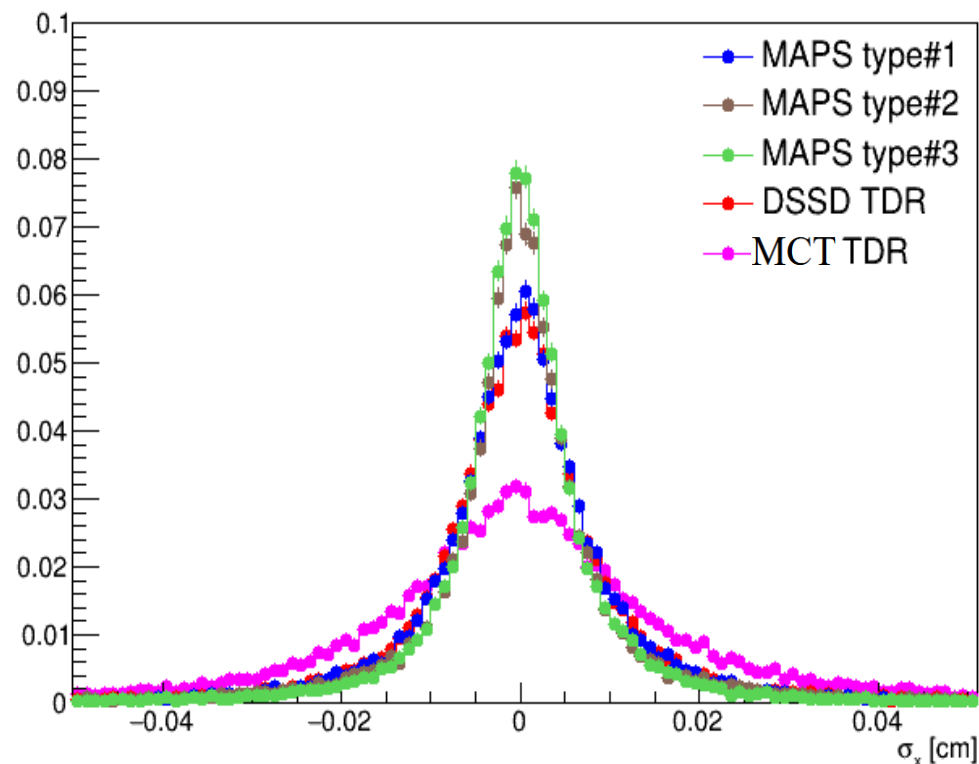


D⁰ SV reconstruction eff. (z position)

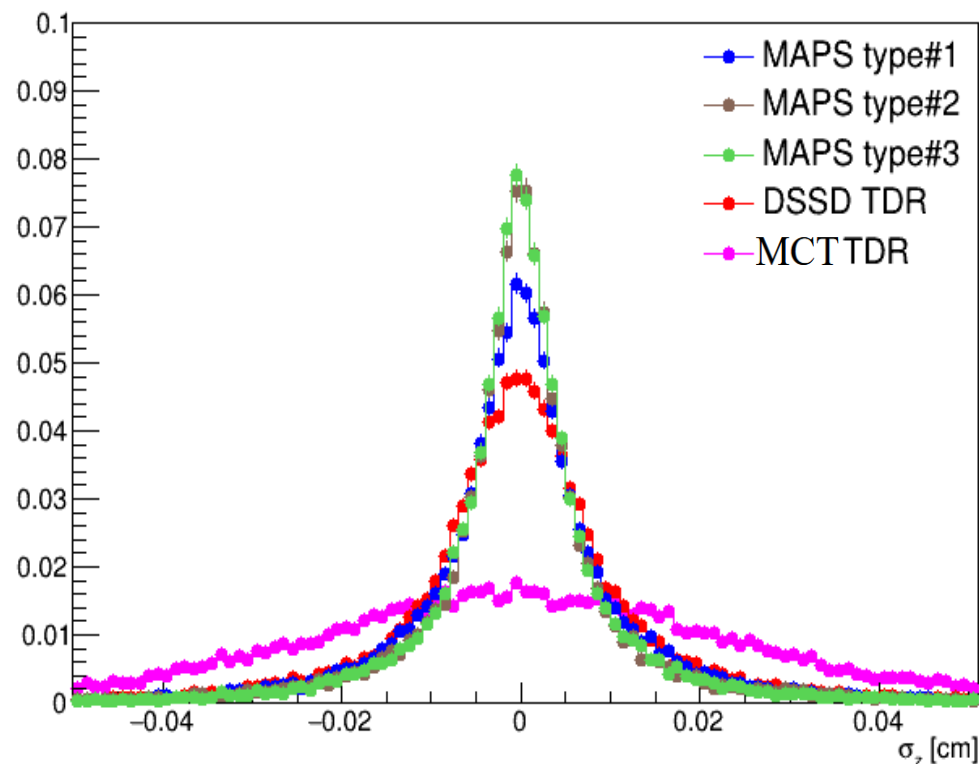


D⁰ vertex resolution | Different options for VD

secondary vertex x-resolution

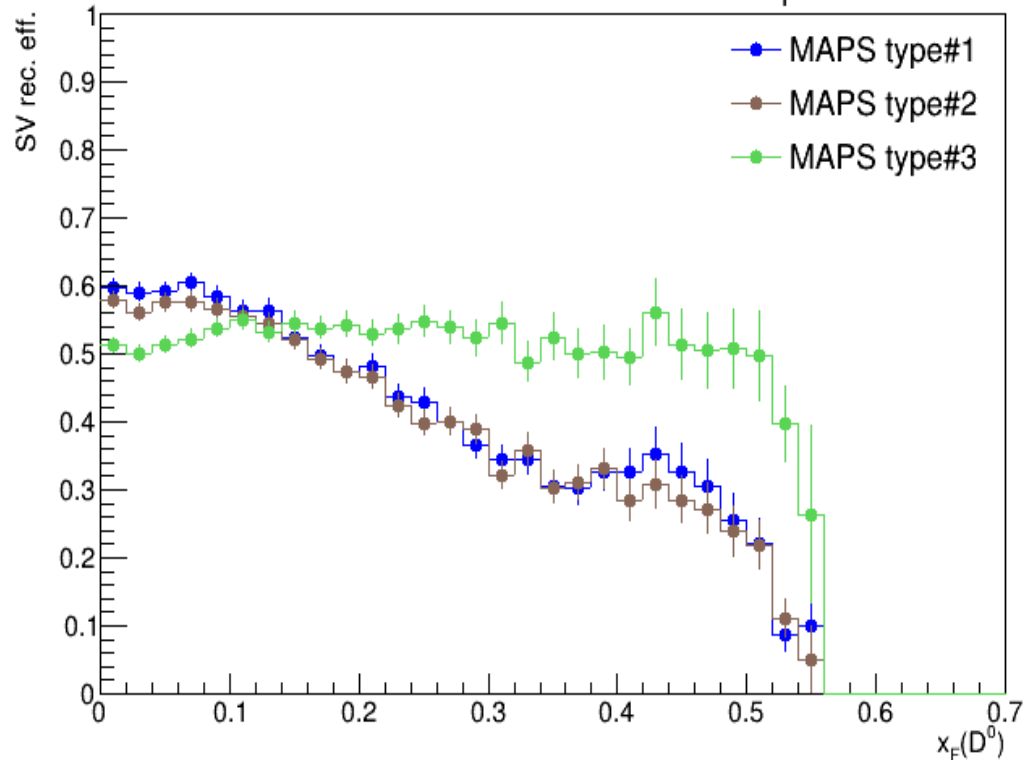


secondary vertex z-resolution

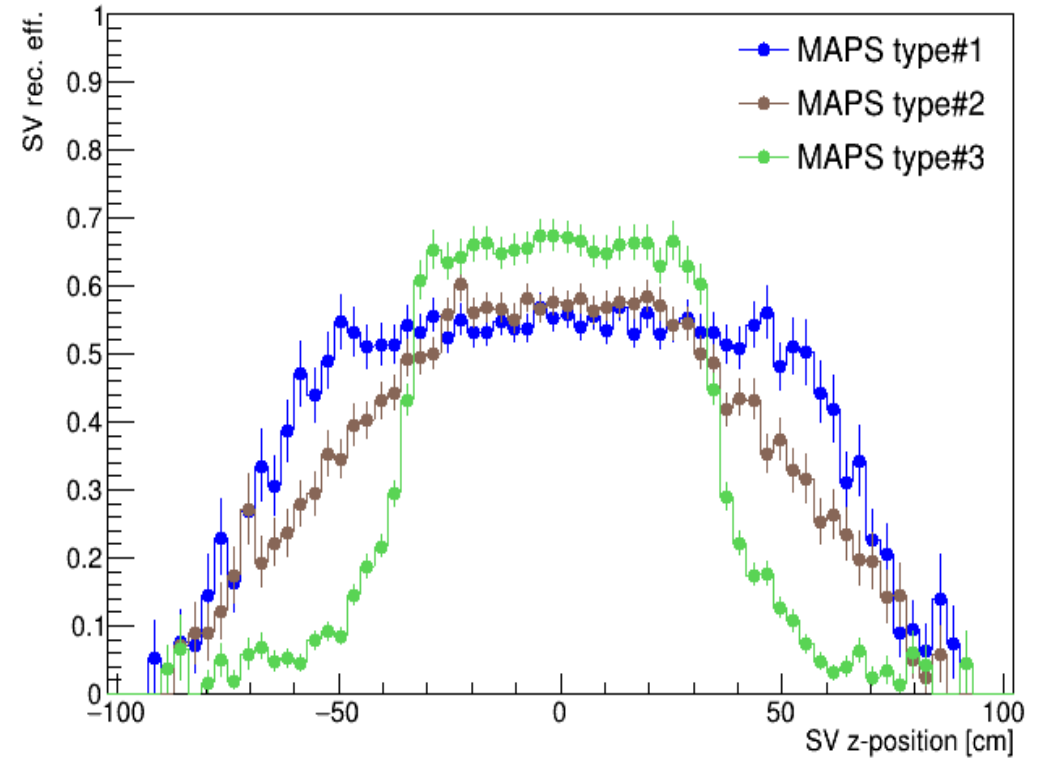


Different options for MAPS-based SVD

D^0 SV reconstruction eff. (x_F)



D^0 SV reconstruction eff. (z position)



Recommendation of using SVD in simulation

- You can **use prepared** configurations:
 - ➔ DSSD TDR: `SpdDssdGeoMapper::Instance()->SetGeometryPars(1)`
 - ➔ MAPS#1: `SpdMapsGeoMapper::Instance()->SetGeometryPars(3)`
 - ➔ MAPS#2: `SpdMapsGeoMapper::Instance()->SetGeometryPars(2)`
 - ➔ MAPS#3: `SpdMapsGeoMapper::Instance()->SetGeometryPars(1)`
- **Default** gtype parameters:
 - DSSD: 1
 - MAPS: 1
- It is possible to make **user custom** config (SetGeometryPars should not be used in that case). Useful methods:
 - Both MAPS & DSSD (see Ap. 6 for parameters description):
 - `<GeoMapper>::SetDefaultLadderPars(Int_t nlayer, Int_t npar, Double_t value);` // to change the list of default layer/ladder parameters
 - `<GeoMapper>::SetDefaultChipPars(Int_t nlayer, Int_t npar, Double_t value);` // to change the list of default chip parameters
 - `<GeoMapper>::SetNLayers(Int_t nlayers);` // force number of layers
 - Only MAPS:
 - `SpdMapsGeoMapper::SetECLayerPosZ(Int_t nlayer, Double_t PosZ);` // Position of layer along Z radius
 - `SpdMapsGeoMapper::SetECLayerRmin(Int_t nlayer, Double_t Rmin);` // min radius of EC layer
 - `SpdMapsGeoMapper::SetECLayerRmax(Int_t nlayer, Double_t Rmax);` // max radius of EC layer
 - `SpdMapsGeoMapper::SetECLayerDz(Int_t nlayer, Double_t Dz);` // distance between sensor planes
 - `SpdMapsGeoMapper::SetECLayerNhalfCones(Int_t nlayer, Double_t NHalfCones);` // number of half cones inside layer (4 - 2 sensor planes, 2 - 1 sensor plane)
 - `SpdMapsGeoMapper::SetNECLayers(Int_t nlayers);` // force number of EC layers

Conclusion

- FEE modules for MCT detectors were simulated;
- FEE modules do not affect the overall performance of the MCT detector, however, they significantly deteriorate the resolution for tracks that pass directly through the electronics;
- SVD is needed to achieve the required secondary vertex position resolution;
- MAPS is still better than DSSD:
 - At least $\sim 10\%$ (σ_z & RMS) better resolution in beam direction for MAPS#1;
 - $\sim 30\%$ σ_z & $\sim 25\%$ RMS better resolution in beam direction for MAPS#3;
- End-caps significantly improve reconstruction of SV of D0 decays efficiency for events with high x_F^{D0} values;

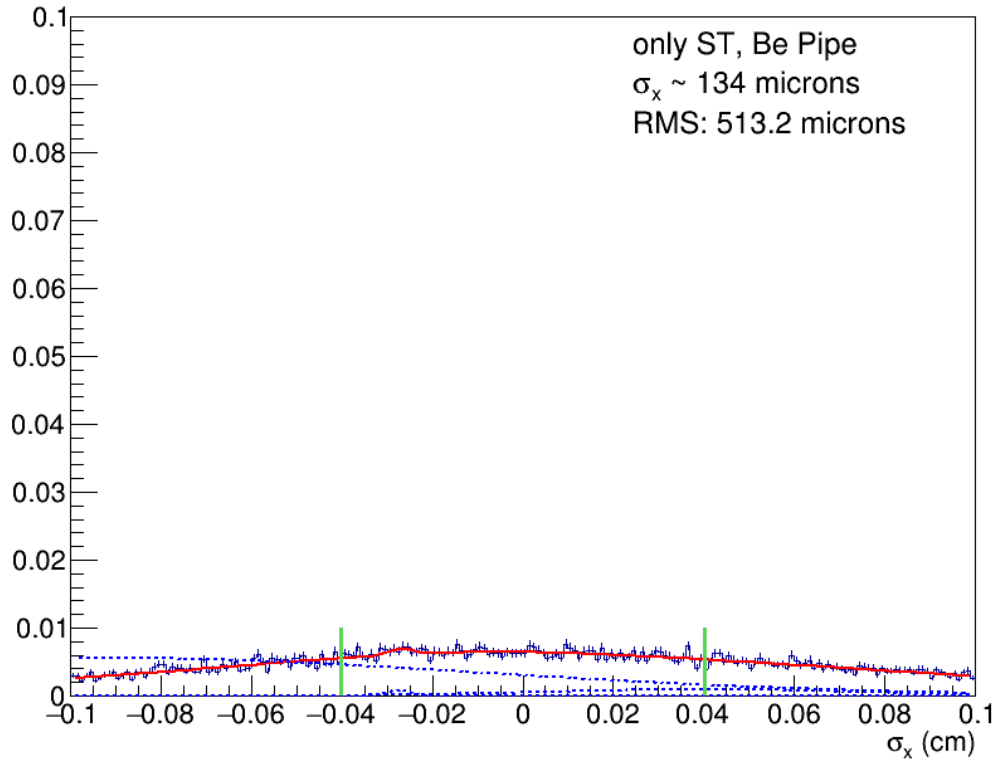
ToDo

- Push MCT Electrics class to SpdRoot development branch;
- End-caps for Micromegas-based central tracker (see A.Datta talk);
- Writing a Wiki page containing information about the geometric model of SVD and instructions for its use for simulation;

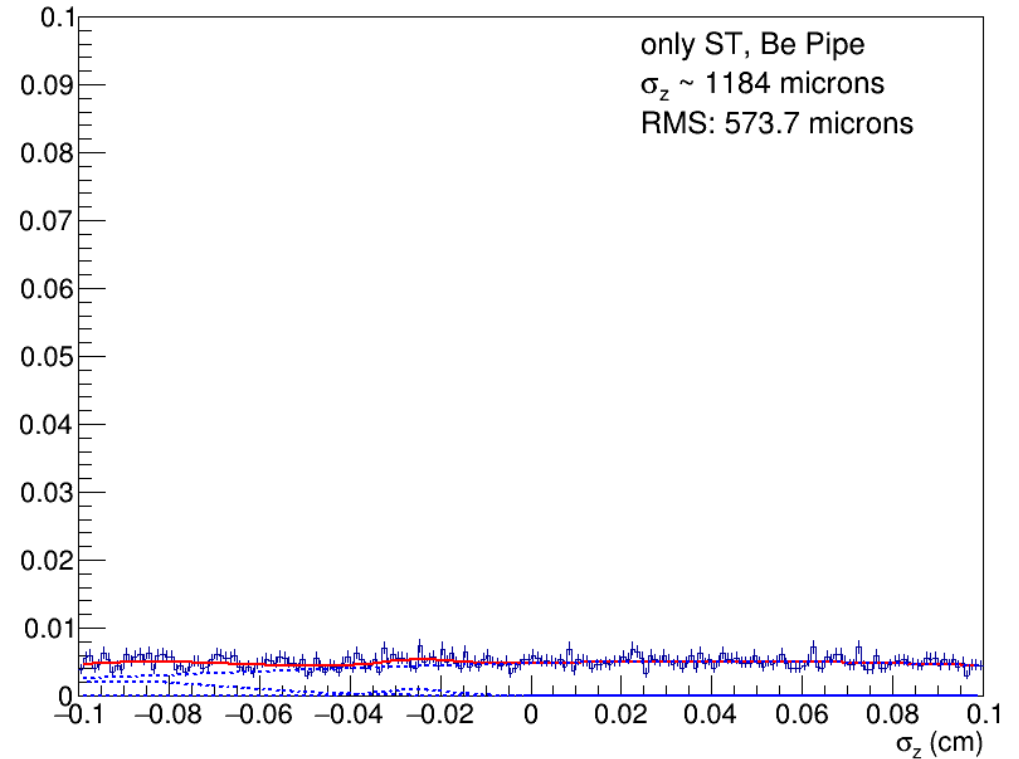
Thank you for your attention!

Ap. 1 | SV reconstruction with only ST config.

D0 $\rightarrow \pi^+ + K^-$: secondary vertex x-resolution

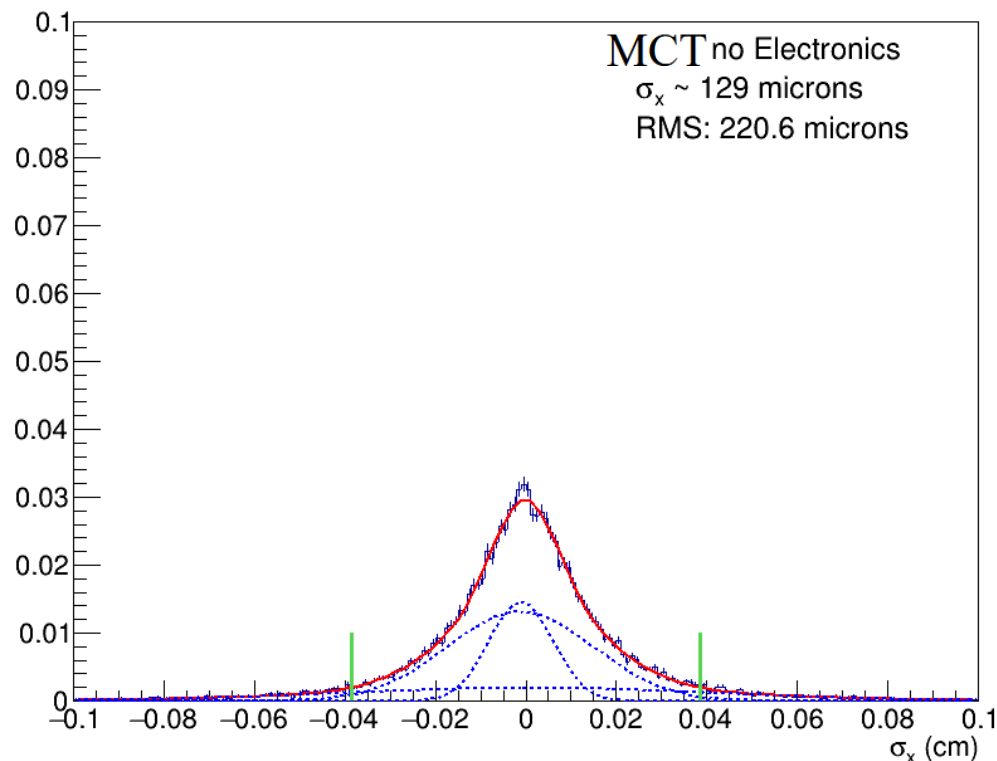


D0 $\rightarrow \pi^+ + K^-$: secondary vertex z-resolution

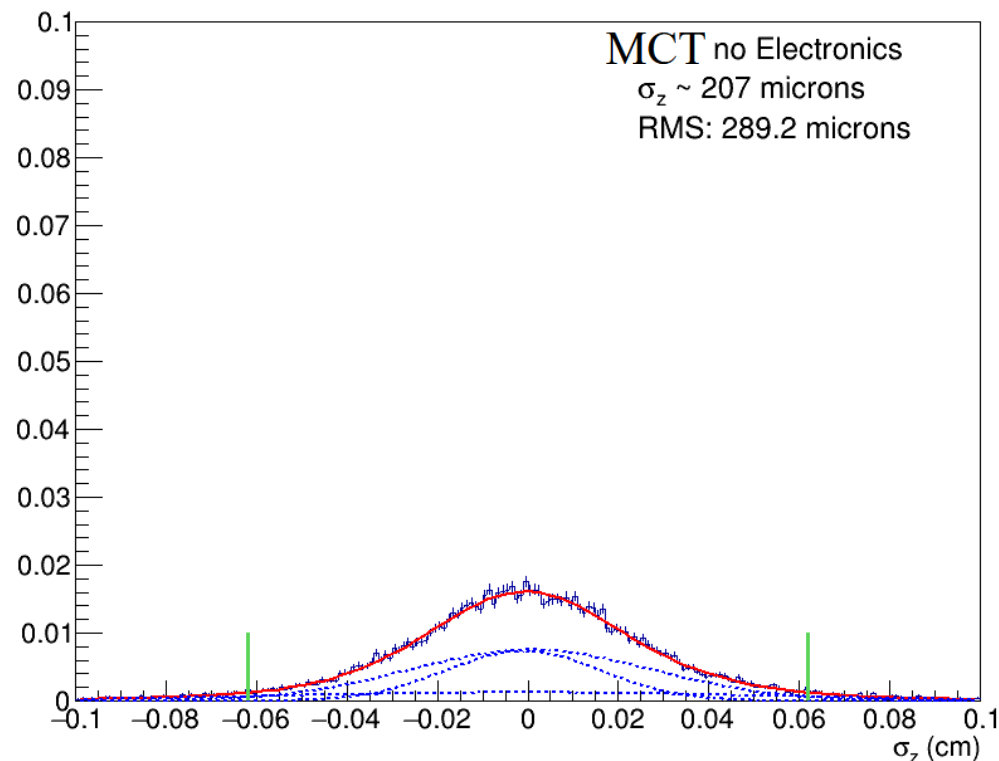


Ap. 2 | SV reconstruction with MCT (1)

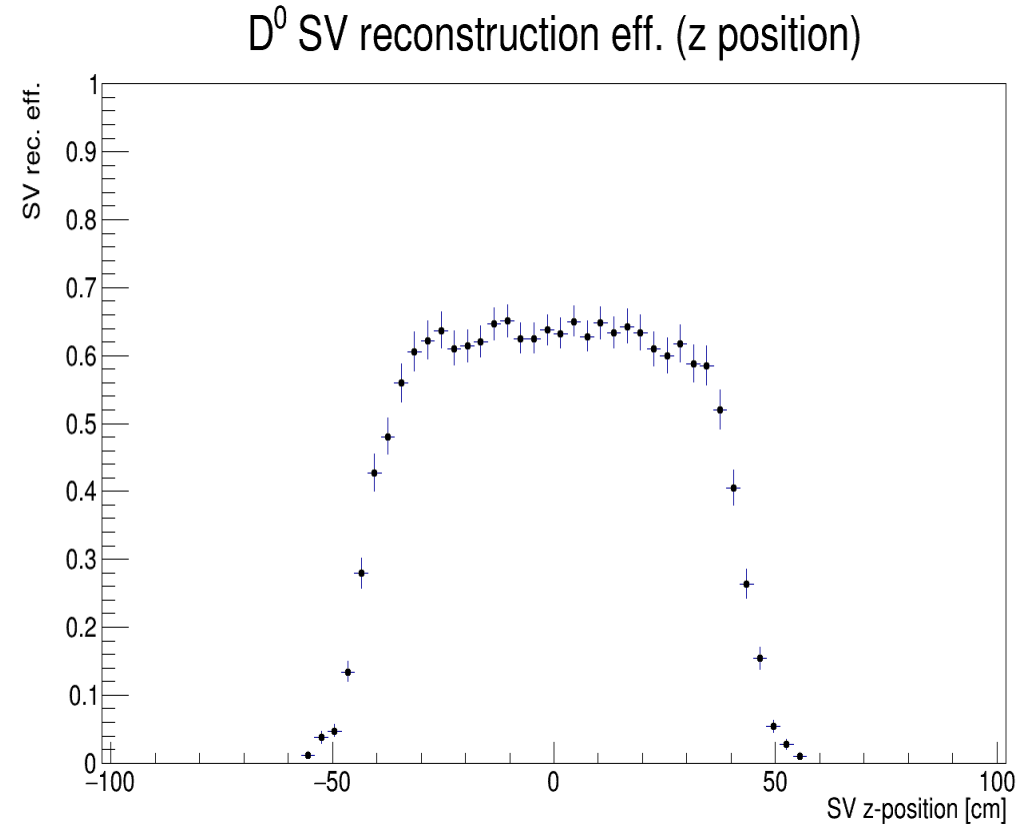
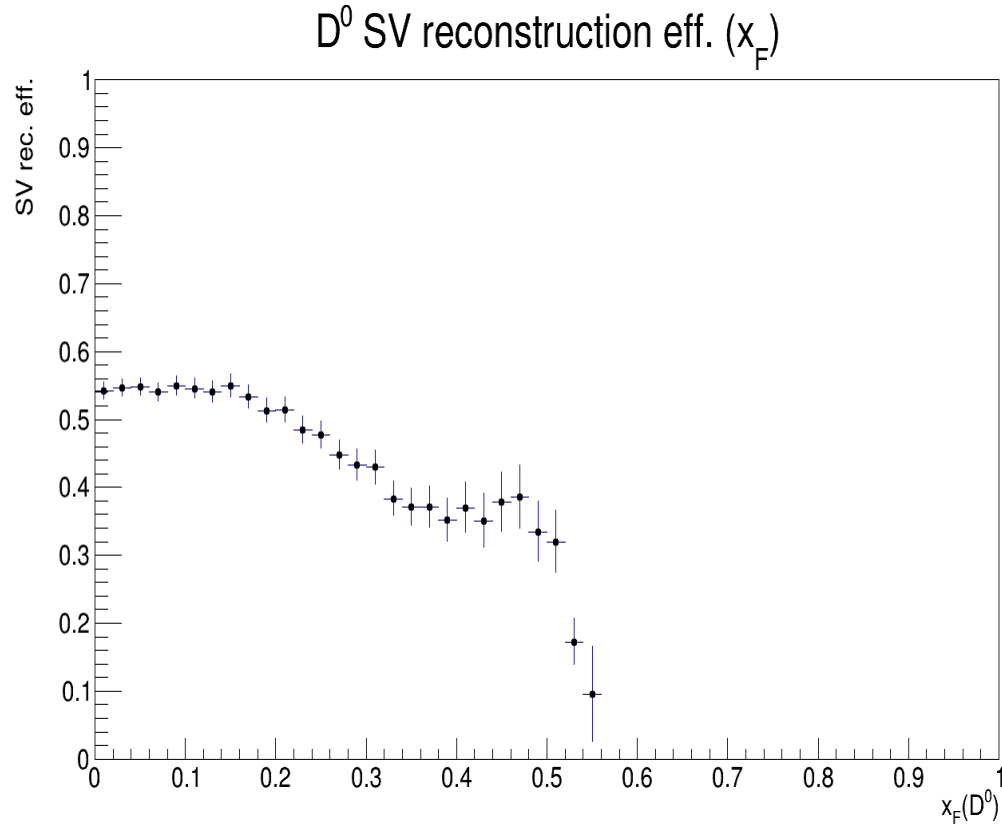
D0 $\rightarrow \pi^+ + K^-$: secondary vertex x-resolution



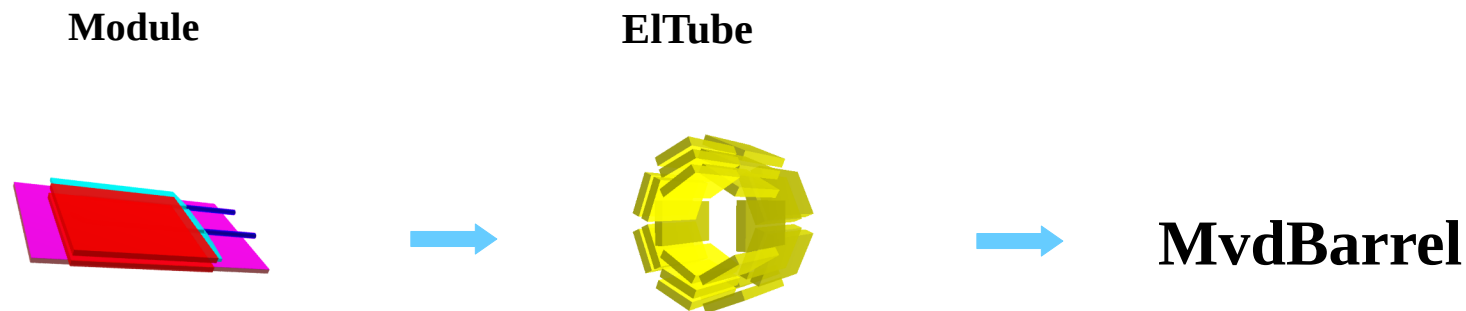
D0 $\rightarrow \pi^+ + K^-$: secondary vertex z-resolution



Ap. 2 | SV reconstruction with MCT (2)



Ap. 3 | FEE for MCT



Current solution:

// Check that master volume contains MVD barrel

```
if (!fMasterVolume->GetNode("MvdBarrel_1"))  
{ cout << "-E- <SpdMvdElectrics::ConstructGeometry> No Mvd Barrel " << endl; return; }  
TGeoVolume *mvd_barrel = fMasterVolume->FindNode("MvdBarrel_1")->GetVolume();
```

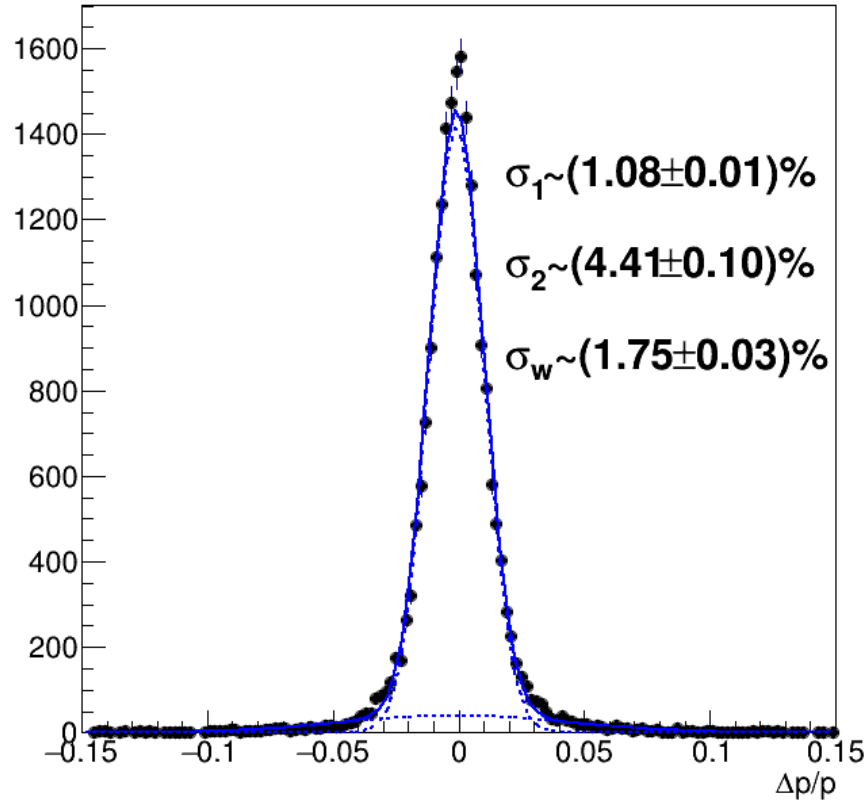
// Put electrics module into MVD barrel

```
mvd_barrel->AddNode(fElTube, 1, new TGeoTranslation(0., 0., -fZshift));  
mvd_barrel->AddNode(fElTube, 2, new TGeoCombiTrans(0., 0., fZshift, new TGeoRotation("fElTubeRot", 0.,  
180., 0.)));
```

Ap. 4 | Comparing momentum resolution: MVD vs ST only

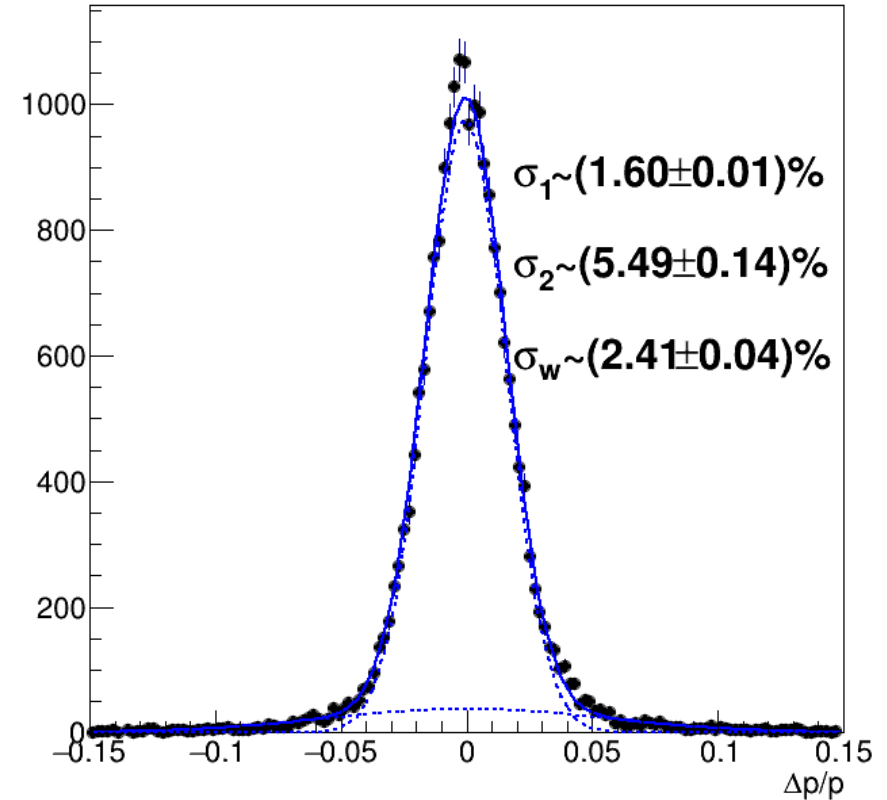
ST + MVD

Resolution



ST only

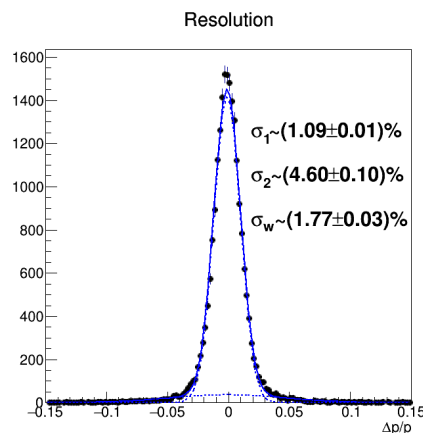
Resolution



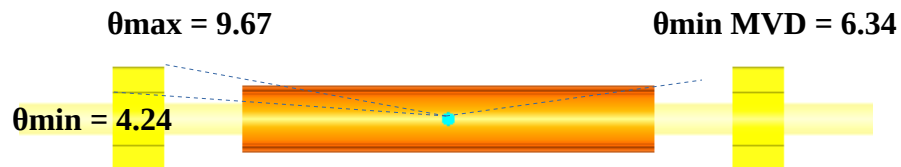
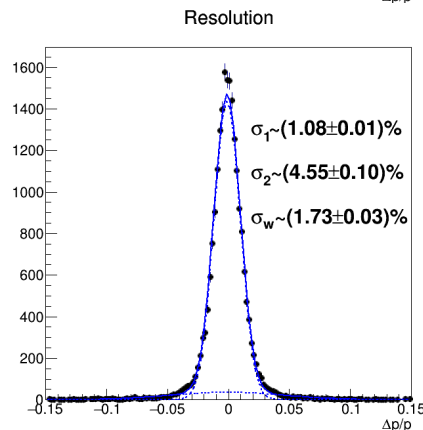
Ap. 5 | VD performance | MVD with electrics#1

Mvd customize geometry: CustomMvd(3);
Barrel length: 90 cm.

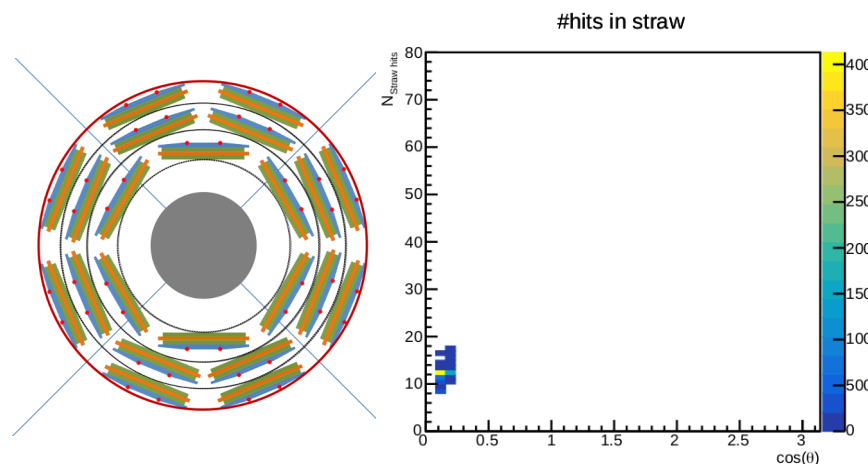
Without FE
Modules



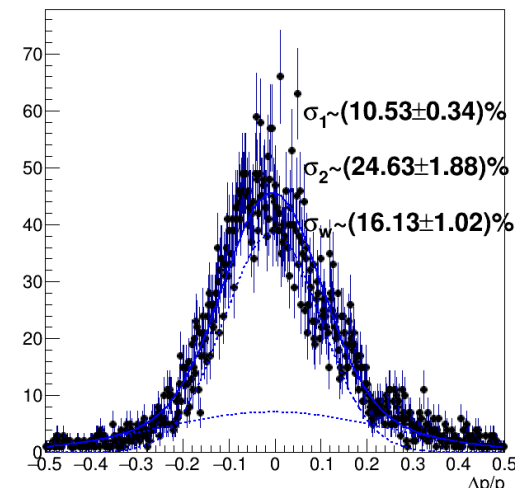
With FE
Modules



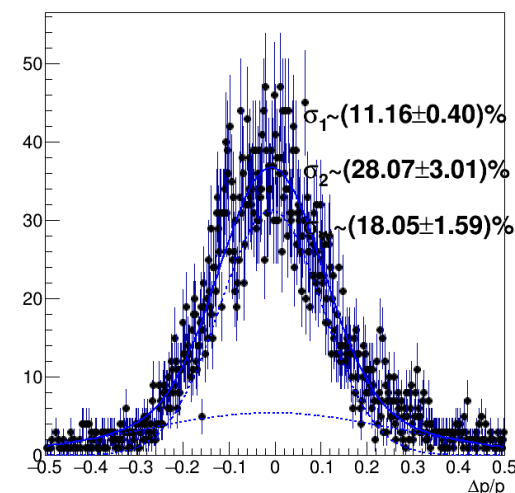
```
IGen->SetSpherical(4.2484545, 9.6666064, 0., 360.);  
primGen->SetBeam(0., 0., 0., 0.);  
primGen->SetTarget(0., 0.);
```



Resolution Without FE



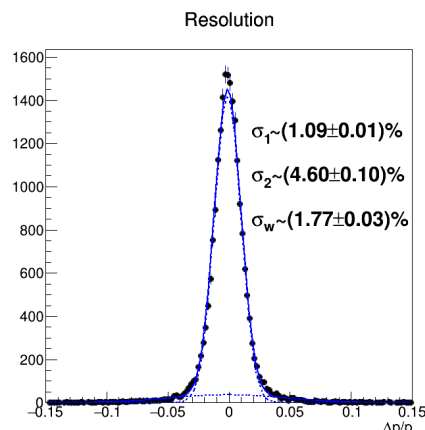
Resolution With FE



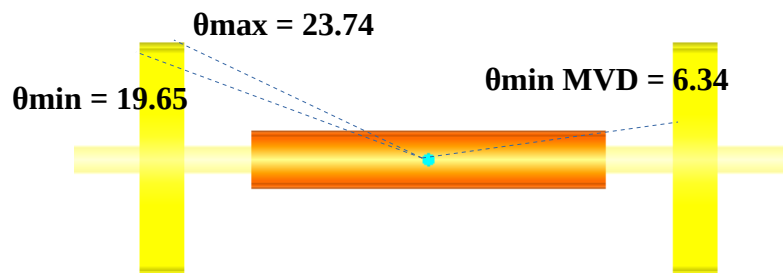
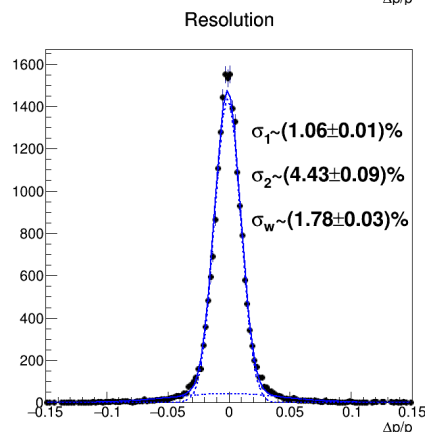
Ap. 5 | VD performance | MVD with electrics#2

Mvd customize geometry: CustomMvd(3);
Barrel length: 90 cm.

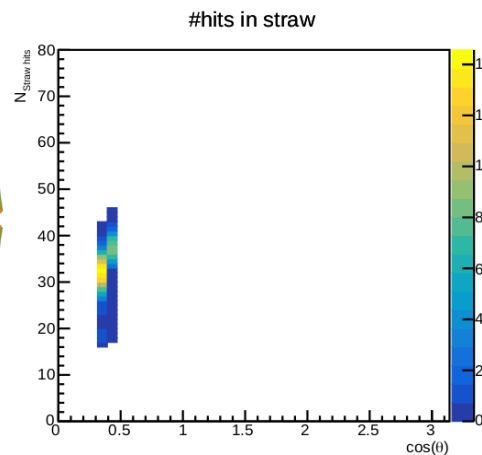
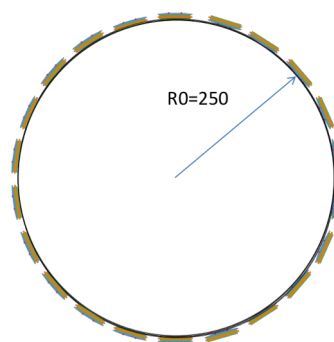
Without FE
Modules



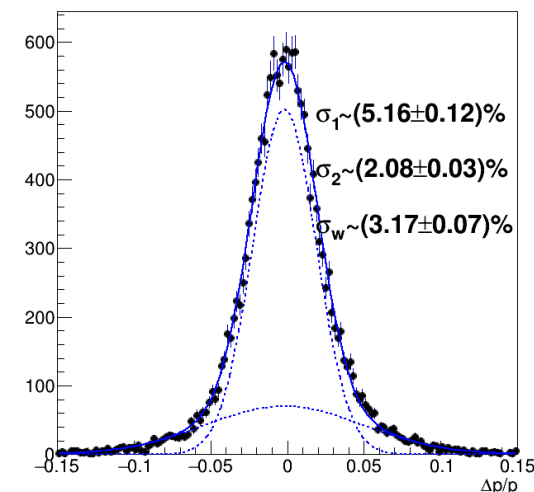
With FE
Modules



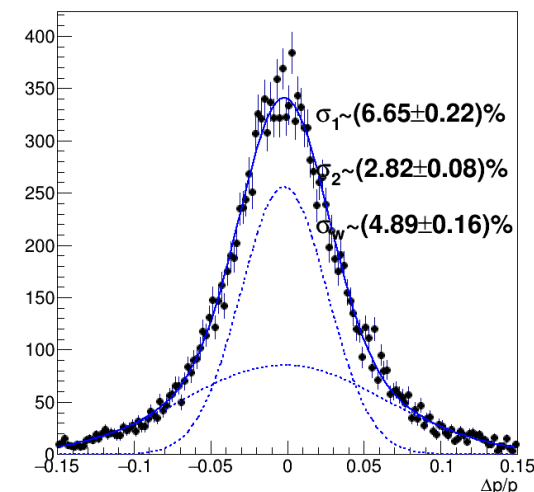
```
IGen->SetSpherical(19.653824, 23.736453, 0., 360.);  
primGen->SetBeam(0., 0., 0., 0.);  
primGen->SetTarget(0., 0.);
```



Resolution Without FE



Resolution With FE



Ap. 6 | SVD parameters

- (1) Rlayer : the distance from z-axis to ladder center (LAYER radius)
- (2) Lz : ladder size along z axis
- (3) Lphi : ladder size along phi axis
- (4) Lr : radial size of ladder
- (5) angle : local rotation angle for ladder
- (6) Phi : global rotation angle for LAYER
- (7) Nladders : number of ladders inside the LAYER (it will be calculated automatically for $g = 1,2$)

SetDefaultLadderPars

- (1) lz : chip size along z-axis
- (2) lphi : chip phi-size
- (3) dlz : gap size between chips along z-axis
- (4) dlphi : gap size between chips along phi-axis
- (5) ncz : number of chip cells (channels) along z-axis
- (6) ncphi : number of chip cells (channels) along phi-axis
- (7) type : chip type (1: MAPS, 2: DSSD) // legacy (to be fixed)

SetDefaultChipPars

- (1) PozZ : Position of layer along Z radius
- (2) dz : distance between sensor planes
- (3) Lz : layer size along z axis
- (4) Rmin : min radius of EC layer
- (5) Rmax : max radius of EC layer
- (3) LzC : HalfCone size along z axis
- (4) RminC : min radius of EC HalfCone
- (5) RmaxC : max radius of EC HalfCone
- (9) Lx : ladder size along x axis (analog of Lphi for barrel)
- (10) Lymin : min ladder size along y axis (Lz for barrel)
- (11) nHalfCones : number of half cones inside layer (4 - 2 sensor planes, 2 - 1 sensor plane)

Ap. 7 | D0 vertex reconstructions efficiency

Source tracks for analysis:

- `track->GetIsFitted() == true;`

Conditions for the existence of a reconstructed SV D^0 vertex in the event:

- Reconstructed vertex exists;
- Mass of «mother» particle lies in the range:
(1.7, 2.0) GeV;